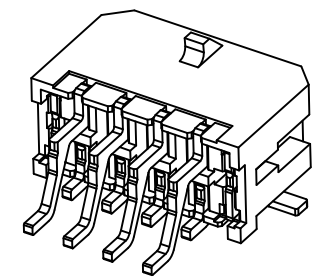


REV	DESCRIPTION	DESIGN	DATE
A0			

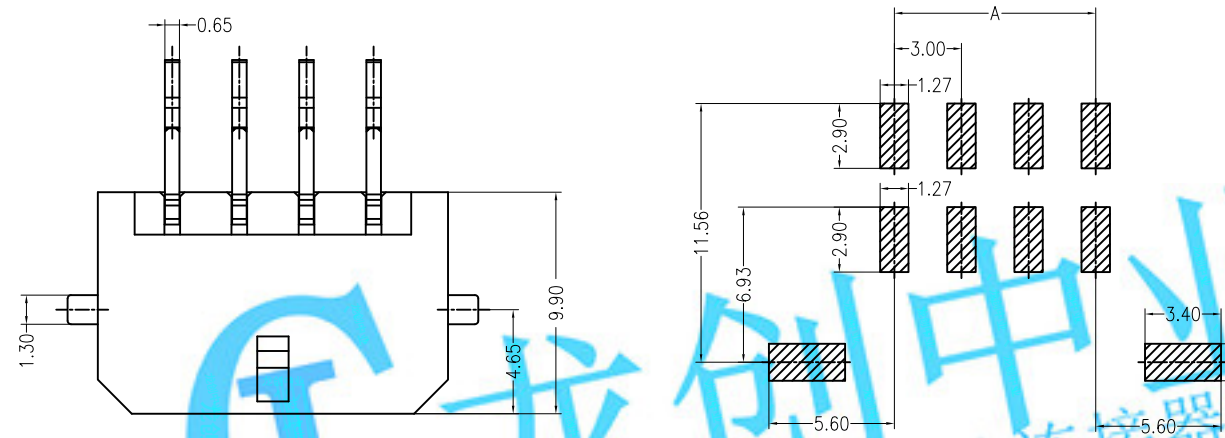
MX-3.0-2xXP-WT

PIN	DIM A	DIM B
2x1		6.65
2x2	3.00	9.65
2x3	6.00	12.65
2x4	9.00	15.65
2x5	12.00	18.65
2x6	15.00	21.65
2x7	18.00	24.65
2x8	21.00	27.65
2x9	24.00	30.65
2x10	27.00	33.65
2x11	30.00	36.65
2x12	33.00	39.65

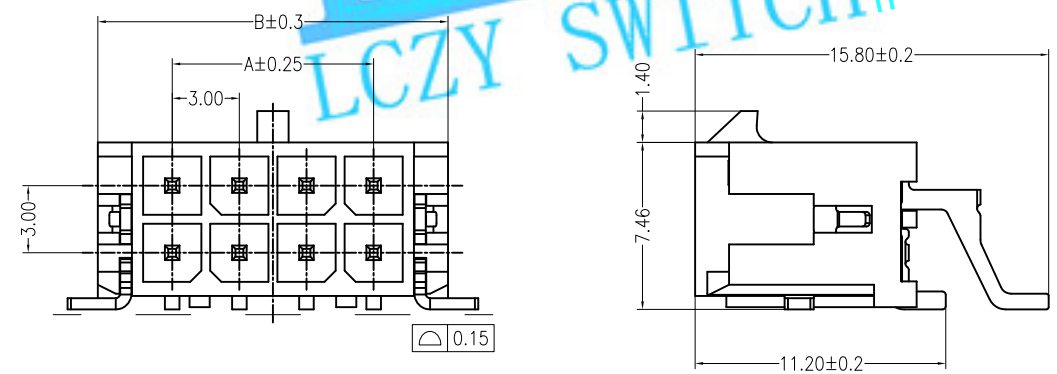


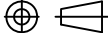
Specifications:

- Contact resistance: $\leq 10\text{m}\Omega$
- Insulation resistance: $\geq 1000\text{M}\Omega$
- Rated voltage: 250V AC DC
- Rated current: 5.0A AC DC
- Withstand Voltage: 1000V AC/minute
- Temperature Range: $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$
- Housing: LCP UL94V-0, BLACK
- Contacts: Brass/MATTE Sn-plated
- Solder Tabs: Brass/MATTE Sn-plated



PCB LAYOUT(Tolerance: ± 0.05)



龙创中业电子科技(东莞) 有限公司				TITLE: 3.0 Pitch Wafer 90° SMT	
GENERAL TOLERANCE		USE: CUSTOMER		PART NO.:	
X. ±0.50	X. ±5°	APPD:			
X.X ±0.30	X.X ±2°	CHKD:		DWG NO.:MX-3.0-2xXP-WT	
X.XX ±0.20	X.XX ±1°				
	UNITS: mm	DR:		SCALE 1 : 1	SHEET 1 / 1